

# 74ALVCH16374

2.5 V/3.3 V 16-bit edge-triggered D-type flip-flop; 3-state

Rev. 03 — 27 April 2010

Product data sheet

## 1. General description

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The 74ALVCH16374 is 16-bit edge-triggered flip-flop featuring separate D-type inputs for each flip-flop and 3-state outputs for bus oriented applications.

Incorporates bus hold data inputs which eliminate the need for external pull-up or pull-down resistors to hold unused inputs.

The 74ALVCH16374 consists of 2 sections of eight edge-triggered flip-flops. A clock (CP) input and an output enable ( $\overline{OE}$ ) are provided per 8-bit section.

The flip-flops will store the state of their individual D-inputs that meet the set-up and hold time requirements on the LOW-to-HIGH CP transition.

When  $\overline{OE}$  is LOW, the contents of the flip-flops are available at the outputs. When  $\overline{OE}$  is HIGH, the outputs go the high-impedance OFF-state. Operation of the  $\overline{OE}$  input does not affect the state of the flip-flops.

## 2. Features and benefits

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- Wide supply voltage range from 1.2 V to 3.6 V
- Complies with JEDEC standard JESD8-B
- CMOS low power consumption
- MULTIBYTE flow-through standard pin-out architecture
- Low inductance multiple  $V_{CC}$  and GND pins for minimum noise and ground bounce
- Direct interface with TTL levels
- All data inputs have bus hold
- Output drive capability 50  $\Omega$  transmission lines at 85 °C
- Current drive  $\pm 24$  mA at  $V_{CC} = 3.0$  V

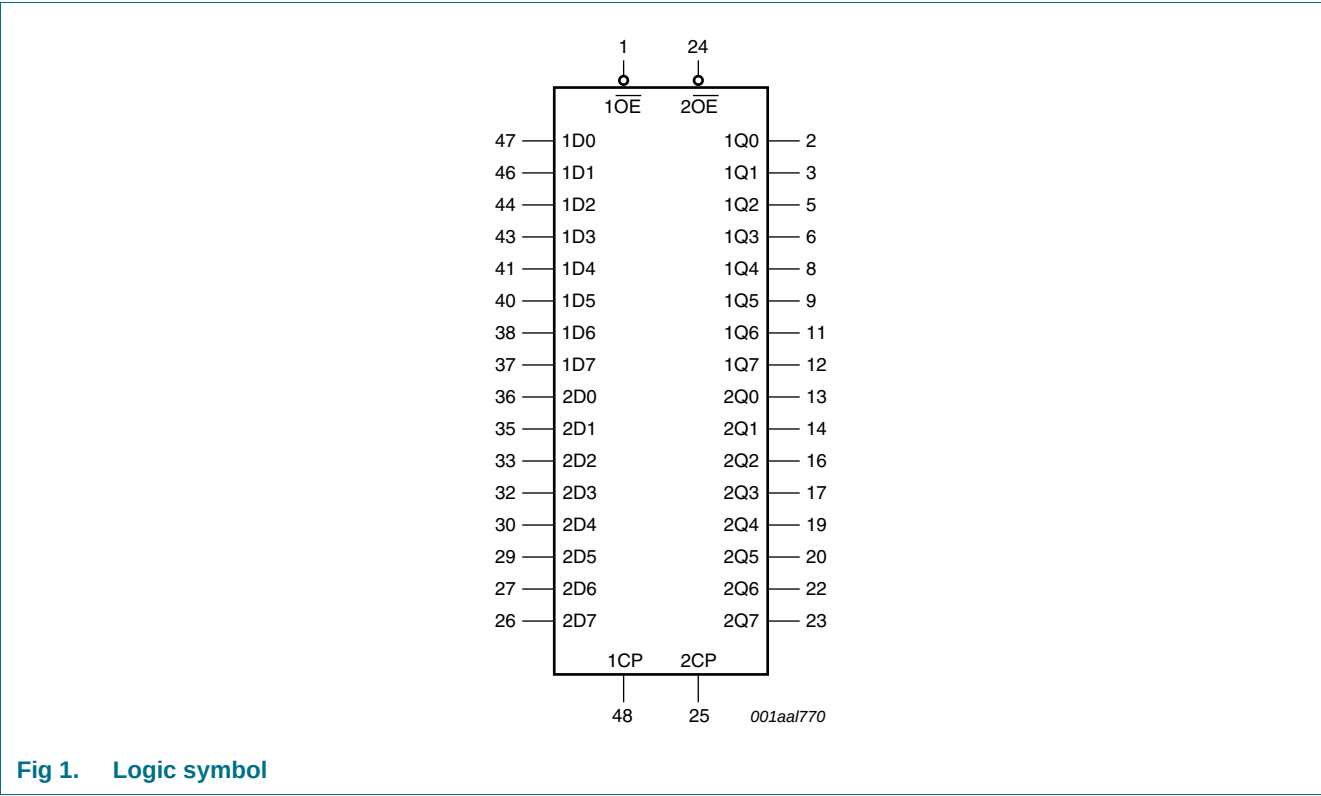


3. Ordering information

Table 1. Ordering information

| Type number    | Temperature range | Package |                                                                        |          |
|----------------|-------------------|---------|------------------------------------------------------------------------|----------|
|                |                   | Name    | Description                                                            | Version  |
| 74ALVCH16374DL | −40 °C to +85 °C  | SSOP48  | plastic shrink small outline package; 48 leads; body width 7.5 mm      | SOT370-1 |
| 74LVCH16374DGG | −40 °C to +85 °C  | TSSOP48 | plastic thin shrink small outline package; 48 leads; body width 6.1 mm | SOT362-1 |

4. Functional diagram



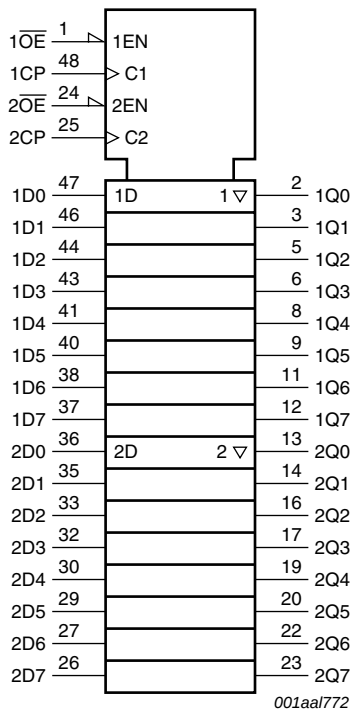


Fig 2. IEC logic symbol

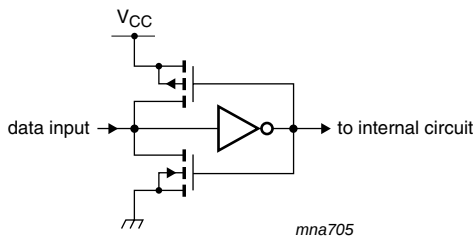


Fig 3. Bus hold circuit

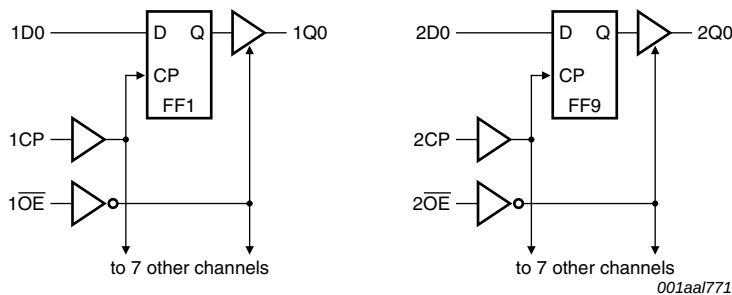


Fig 4. Logic diagram

5. Pinning information

5.1 Pinning

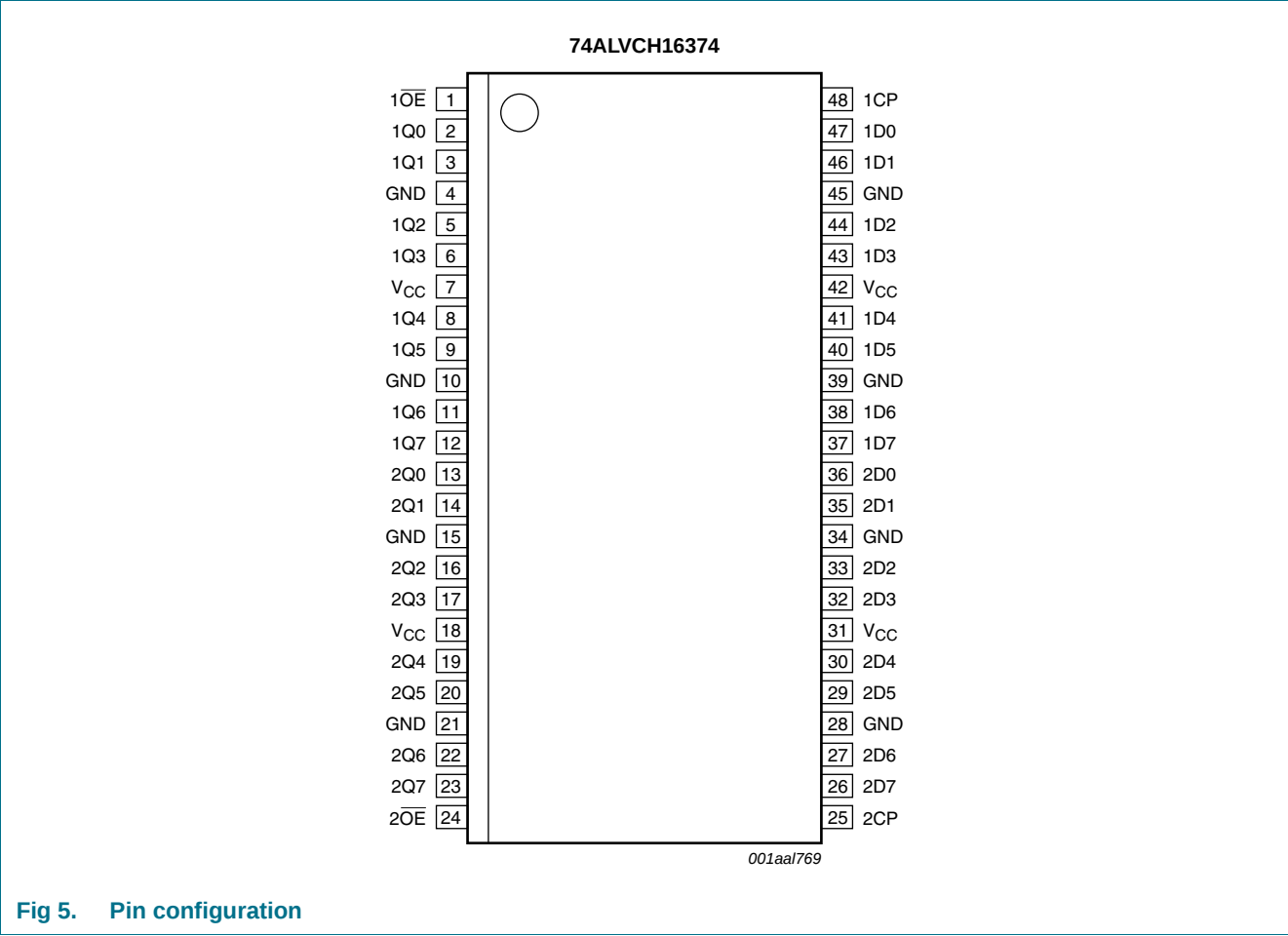


Fig 5. Pin configuration

## 5.2 Pin description

Table 2. Pin description

| Symbol                              | Pin                            | Description                      |
|-------------------------------------|--------------------------------|----------------------------------|
| $\overline{1OE}$ , $\overline{2OE}$ | 1, 24                          | output enable input (active LOW) |
| 1Q0 to 1Q7                          | 2, 3, 5, 6, 8, 9, 11, 12       | 3-state flip-flop outputs        |
| 2Q0 to 2Q7                          | 13, 14, 16, 17, 19, 20, 22, 23 | 3-state flip-flop outputs        |
| GND                                 | 4, 10, 15, 21, 28, 34, 39, 45  | ground (0 V)                     |
| V <sub>CC</sub>                     | 7, 18, 31, 42                  | positive supply voltage          |
| 1D0 to 1D7                          | 47, 46, 44, 43, 41, 40, 38, 37 | data inputs                      |
| 2D0 to 2D7                          | 36, 35, 33, 32, 30, 29, 27, 26 | data inputs                      |
| 1CP, 2CP                            | 48, 25                         | clock input                      |

## 6. Functional description

### 6.1 Function table

Table 3. Function table<sup>[1]</sup>

| Inputs           |                  |    | Internal flip-flops | Outputs Q0 to Q7 | Operating mode                    |
|------------------|------------------|----|---------------------|------------------|-----------------------------------|
| $\overline{nOE}$ | $\overline{nCP}$ | Dn |                     |                  |                                   |
| L                | ↑                | l  | L                   | L                | load and read register            |
| L                | ↑                | h  | H                   | H                |                                   |
| H                | ↑                | l  | L                   | Z                | load register and disable outputs |
| H                | ↑                | h  | H                   | Z                |                                   |

[1] H = HIGH voltage level;

L = LOW voltage level;

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition;

l = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition;

↑ = LOW-to-HIGH clock transition;

Z = high-impedance OFF-state.

## 7. Limiting values

**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol    | Parameter               | Conditions                     | Min      | Max            | Unit |
|-----------|-------------------------|--------------------------------|----------|----------------|------|
| $V_{CC}$  | supply voltage          |                                | -0.5     | +4.6           | V    |
| $I_{IK}$  | input clamping current  | $V_I < 0$ V                    | -50      | -              | mA   |
| $V_I$     | input voltage           | control inputs                 | [1] -0.5 | +4.6           | V    |
|           |                         | data inputs                    | [1] -0.5 | $V_{CC} + 0.5$ | V    |
| $I_{OK}$  | output clamping current | $V_O > V_{CC}$ or $V_O < 0$ V  | -        | ±50            | mA   |
| $V_O$     | output voltage          |                                | [1] -0.5 | $V_{CC} + 0.5$ | V    |
| $I_O$     | output current          | $V_O = 0$ V to $V_{CC}$        | -        | ±50            | mA   |
| $I_{CC}$  | supply current          |                                | -        | 100            | mA   |
| $I_{GND}$ | ground current          |                                | -100     | -              | mA   |
| $T_{stg}$ | storage temperature     |                                | -65      | +150           | °C   |
| $P_{tot}$ | total power dissipation | $T_{amb} = -40$ °C to +125 °C; |          |                |      |
|           |                         | SSOP48 package                 | [2] -    | 850            | mW   |
|           |                         | TSSOP48 package                | [3] -    | 600            | mW   |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] Above 55 °C the value of  $P_{tot}$  derates linearly with 11.3 mW/K.

[3] Above 55 °C the value of  $P_{tot}$  derates linearly with 8 mW/K.

## 8. Recommended operating conditions

**Table 5. Recommended operating conditions**

| Symbol              | Parameter                           | Conditions                | Min | Typ | Max      | Unit |
|---------------------|-------------------------------------|---------------------------|-----|-----|----------|------|
| $V_{CC}$            | supply voltage                      | maximum speed performance |     |     |          |      |
|                     |                                     | $C_L = 30$ pF             | 2.3 | -   | 2.7      | V    |
|                     |                                     | $C_L = 50$ pF             | 3.0 | -   | 3.6      | V    |
|                     |                                     | low voltage applications  | 1.2 | -   | 3.6      | V    |
| $V_I$               | input voltage                       | data inputs               | 0   | -   | $V_{CC}$ | V    |
|                     |                                     | control inputs            | 0   | -   | 5.5      | V    |
| $V_O$               | output voltage                      |                           | 0   | -   | $V_{CC}$ | V    |
| $T_{amb}$           | ambient temperature                 | in free air               | -40 | -   | +85      | °C   |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 2.3$ V to 3.0 V | 0   | -   | 20       | ns/V |
|                     |                                     | $V_{CC} = 3.0$ V to 3.6 V | 0   | -   | 10       | ns/V |

## 9. Static characteristics

**Table 6. Static characteristics**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol                                    | Parameter                       | Conditions                                                                                    | Min                   | Typ <sup>[1]</sup>     | Max                | Unit |
|-------------------------------------------|---------------------------------|-----------------------------------------------------------------------------------------------|-----------------------|------------------------|--------------------|------|
| <b>T<sub>amb</sub> = -40 °C to +85 °C</b> |                                 |                                                                                               |                       |                        |                    |      |
| V <sub>IH</sub>                           | HIGH-level input voltage        | V <sub>CC</sub> = 1.2 V                                                                       | V <sub>CC</sub>       | -                      | -                  | V    |
|                                           |                                 | V <sub>CC</sub> = 1.8 V                                                                       | 0.7V <sub>CC</sub>    | 0.9                    | -                  | V    |
|                                           |                                 | V <sub>CC</sub> = 2.3 V to 2.7 V                                                              | 1.7                   | 1.2                    | -                  | V    |
|                                           |                                 | V <sub>CC</sub> = 2.7 V to 3.6 V                                                              | 2.0                   | 1.5                    | -                  | V    |
| V <sub>IL</sub>                           | LOW-level input voltage         | V <sub>CC</sub> = 1.2 V                                                                       | -                     | -                      | 0                  | V    |
|                                           |                                 | V <sub>CC</sub> = 1.8 V                                                                       | -                     | 0.9                    | 0.2V <sub>CC</sub> | V    |
|                                           |                                 | V <sub>CC</sub> = 2.3 V to 2.7 V                                                              | -                     | 1.2                    | 0.7                | V    |
|                                           |                                 | V <sub>CC</sub> = 2.7 V to 3.6 V                                                              | -                     | 1.5                    | 0.8                | V    |
| V <sub>OH</sub>                           | HIGH-level output voltage       | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                           |                       |                        |                    |      |
|                                           |                                 | I <sub>O</sub> = -100 µA; V <sub>CC</sub> = 1.8 V to 3.6 V                                    | V <sub>CC</sub> - 0.2 | V <sub>CC</sub>        | -                  | V    |
|                                           |                                 | I <sub>O</sub> = -6 mA; V <sub>CC</sub> = 1.8 V                                               | V <sub>CC</sub> - 0.4 | V <sub>CC</sub> - 0.1  | -                  | V    |
|                                           |                                 | I <sub>O</sub> = -6 mA; V <sub>CC</sub> = 2.3 V                                               | V <sub>CC</sub> - 0.3 | V <sub>CC</sub> - 0.08 | -                  | V    |
|                                           |                                 | I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.3 V                                              | V <sub>CC</sub> - 0.5 | V <sub>CC</sub> - 0.17 | -                  | V    |
|                                           |                                 | I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.7 V                                              | V <sub>CC</sub> - 0.5 | V <sub>CC</sub> - 0.14 | -                  | V    |
|                                           |                                 | I <sub>O</sub> = -18 mA; V <sub>CC</sub> = 2.3 V                                              | V <sub>CC</sub> - 0.6 | V <sub>CC</sub> - 0.26 | -                  | V    |
|                                           |                                 | I <sub>O</sub> = -24 mA; V <sub>CC</sub> = 3.0 V                                              | V <sub>CC</sub> - 1.0 | V <sub>CC</sub> - 0.28 | -                  | V    |
| V <sub>OL</sub>                           | LOW-level output voltage        | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                           |                       |                        |                    |      |
|                                           |                                 | I <sub>O</sub> = 100 µA; V <sub>CC</sub> = 1.8 V to 3.6 V                                     | -                     | 0                      | 0.20               | V    |
|                                           |                                 | I <sub>O</sub> = 6 mA; V <sub>CC</sub> = 1.8 V                                                | -                     | 0.09                   | 0.30               | V    |
|                                           |                                 | I <sub>O</sub> = 6 mA; V <sub>CC</sub> = 2.3 V                                                | -                     | 0.07                   | 0.20               | V    |
|                                           |                                 | I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.3 V                                               | -                     | 0.15                   | 0.40               | V    |
|                                           |                                 | I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V                                               | -                     | 0.14                   | 0.40               | V    |
|                                           |                                 | I <sub>O</sub> = 18 mA; V <sub>CC</sub> = 2.3 V                                               | -                     | 0.23                   | 0.60               | V    |
|                                           |                                 | I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V                                               | -                     | 0.27                   | 0.55               | V    |
| I <sub>I</sub>                            | input leakage current           | V <sub>CC</sub> = 1.8 V to 3.6 V                                                              |                       |                        |                    |      |
|                                           |                                 | control input; V <sub>I</sub> = 5.5 V or GND                                                  | -                     | 0.1                    | 5                  | µA   |
|                                           |                                 | data input; V <sub>I</sub> = V <sub>CC</sub> or GND                                           | -                     | 0.1                    | 5                  | µA   |
| I <sub>OZ</sub>                           | OFF-state output current        | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>O</sub> = V <sub>CC</sub> or GND |                       |                        |                    |      |
|                                           |                                 | V <sub>CC</sub> = 1.8 V to 2.7 V                                                              | -                     | 0.1                    | 5                  | µA   |
|                                           |                                 | V <sub>CC</sub> = 2.7 V to 3.6 V                                                              | -                     | 0.1                    | 10                 | µA   |
| I <sub>LIZ</sub>                          | OFF-state input leakage current | V <sub>I</sub> = V <sub>CC</sub> or GND                                                       |                       |                        |                    |      |
|                                           |                                 | V <sub>CC</sub> = 1.8 V to 2.7 V                                                              | -                     | 0.1                    | 10                 | µA   |
|                                           |                                 | V <sub>CC</sub> = 3.6 V                                                                       | -                     | 0.1                    | 15                 | µA   |
| I <sub>CC</sub>                           | supply current                  | V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A;                                |                       |                        |                    |      |
|                                           |                                 | V <sub>CC</sub> = 1.8 V to 2.7 V                                                              | -                     | 0.1                    | 20                 | µA   |
|                                           |                                 | V <sub>CC</sub> = 2.7 V to 3.6 V                                                              | -                     | 0.2                    | 40                 | µA   |

**Table 6.** Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol          | Parameter                       | Conditions                                                                                         | Min | Typ <sup>[1]</sup> | Max  | Unit          |
|-----------------|---------------------------------|----------------------------------------------------------------------------------------------------|-----|--------------------|------|---------------|
| $\Delta I_{CC}$ | additional supply current       | $V_I = V_{CC} - 0.6 \text{ V}$ ; $I_O = 0 \text{ A}$ ; $V_{CC} = 2.7 \text{ V}$ to $3.6 \text{ V}$ |     |                    |      |               |
|                 |                                 | per control input                                                                                  | -   | 5                  | 500  | $\mu\text{A}$ |
|                 |                                 | per data I/O input                                                                                 | -   | 150                | 750  | $\mu\text{A}$ |
| $I_{BHL}$       | bus hold LOW current            | $V_{CC} = 2.3 \text{ V}$ ; $V_I = 0.7 \text{ V}$                                                   | [2] | 45                 | -    | $\mu\text{A}$ |
|                 |                                 | $V_{CC} = 3.0 \text{ V}$ ; $V_I = 0.8 \text{ V}$                                                   | [2] | 75                 | 150  | $\mu\text{A}$ |
| $I_{BHH}$       | bus hold HIGH current           | $V_{CC} = 2.3 \text{ V}$ ; $V_I = 1.7 \text{ V}$                                                   | [2] | -45                | -    | $\mu\text{A}$ |
|                 |                                 | $V_{CC} = 3.0 \text{ V}$ ; $V_I = 2.0 \text{ V}$                                                   | [2] | -75                | -175 | $\mu\text{A}$ |
| $I_{BHLO}$      | bus hold LOW overdrive current  | $V_{CC} = 2.7 \text{ V}$                                                                           | [2] | 300                | -    | $\mu\text{A}$ |
|                 |                                 | $V_{CC} = 3.6 \text{ V}$                                                                           | [2] | 450                | -    | $\mu\text{A}$ |
| $I_{BHHO}$      | bus hold HIGH overdrive current | $V_{CC} = 2.7 \text{ V}$                                                                           | [2] | -300               | -    | $\mu\text{A}$ |
|                 |                                 | $V_{CC} = 3.6 \text{ V}$                                                                           | [2] | -450               | -    | $\mu\text{A}$ |
| $C_I$           | input capacitance               |                                                                                                    | -   | 5.0                | -    | pF            |

[1] All typical values are measured at  $T_{amb} = 25^\circ\text{C}$ .

[2] Valid for data inputs of bus hold parts only.

## 10. Dynamic characteristics

**Table 7.** Dynamic characteristicsAt recommended operating conditions. Voltages are referenced to GND (ground = 0 V); test circuit [Figure 9](#).

| Symbol                                               | Parameter         | Conditions                                  | Min | Typ <sup>[1]</sup> | Max | Unit |
|------------------------------------------------------|-------------------|---------------------------------------------|-----|--------------------|-----|------|
| $T_{amb} = -40^\circ\text{C}$ to $+85^\circ\text{C}$ |                   |                                             |     |                    |     |      |
| $f_{max}$                                            | maximum frequency | see <a href="#">Figure 6</a>                |     |                    |     |      |
|                                                      |                   | $V_{CC} = 1.8 \text{ V}$                    | 125 | 250                | -   | MHz  |
|                                                      |                   | $V_{CC} = 2.3 \text{ V}$ to $2.7 \text{ V}$ | [2] | 150                | 300 | MHz  |
|                                                      |                   | $V_{CC} = 2.7 \text{ V}$                    | 150 | 300                | -   | MHz  |
|                                                      |                   | $V_{CC} = 3.0 \text{ V}$ to $3.6 \text{ V}$ | [3] | 200                | 350 | MHz  |
| $t_{pd}$                                             | propagation delay | nCP to nQn; see <a href="#">Figure 6</a>    | [4] |                    |     |      |
|                                                      |                   | $V_{CC} = 1.2 \text{ V}$                    | -   | 7.7                | -   | ns   |
|                                                      |                   | $V_{CC} = 1.8 \text{ V}$                    | 1.5 | 3.6                | 6.5 | ns   |
|                                                      |                   | $V_{CC} = 2.3 \text{ V}$ to $2.7 \text{ V}$ | [2] | 1.0                | 2.3 | ns   |
|                                                      |                   | $V_{CC} = 2.7 \text{ V}$                    | 1.0 | 2.3                | 3.8 | ns   |
|                                                      |                   | $V_{CC} = 3.0 \text{ V}$ to $3.6 \text{ V}$ | [3] | 1.0                | 2.4 | ns   |
| $t_{en}$                                             | enable time       | nOE to nQn; see <a href="#">Figure 7</a>    | [4] |                    |     |      |
|                                                      |                   | $V_{CC} = 1.2 \text{ V}$                    | -   | 8.7                | -   | ns   |
|                                                      |                   | $V_{CC} = 1.8 \text{ V}$                    | 1.5 | 4.0                | 7.2 | ns   |
|                                                      |                   | $V_{CC} = 2.3 \text{ V}$ to $2.7 \text{ V}$ | [2] | 1.0                | 2.6 | ns   |
|                                                      |                   | $V_{CC} = 2.7 \text{ V}$                    | 1.0 | 2.9                | 4.8 | ns   |
|                                                      |                   | $V_{CC} = 3.0 \text{ V}$ to $3.6 \text{ V}$ | [3] | 1.0                | 2.3 | ns   |

**Table 7. Dynamic characteristics ...continued**At recommended operating conditions. Voltages are referenced to GND (ground = 0 V); test circuit [Figure 9](#).

| Symbol           | Parameter                     | Conditions                                             | Min | Typ <sup>[1]</sup> | Max | Unit |
|------------------|-------------------------------|--------------------------------------------------------|-----|--------------------|-----|------|
| t <sub>dis</sub> | disable time                  | nOE to nQn; see <a href="#">Figure 7</a>               |     |                    |     |      |
|                  |                               | V <sub>CC</sub> = 1.2 V                                | -   | 6.2                | -   | ns   |
|                  |                               | V <sub>CC</sub> = 1.8 V                                | 1.5 | 3.1                | 5.4 | ns   |
|                  |                               | V <sub>CC</sub> = 2.3 V to 2.7 V                       | 1.0 | 2.1                | 4.0 | ns   |
|                  |                               | V <sub>CC</sub> = 2.7 V                                | 1.0 | 2.9                | 4.5 | ns   |
| t <sub>w</sub>   | pulse width                   | V <sub>CC</sub> = 3.0 V to 3.6 V                       | 1.0 | 2.6                | 4.1 | ns   |
|                  |                               | nCP HIGH or LOW; see <a href="#">Figure 6</a>          |     |                    |     |      |
|                  |                               | V <sub>CC</sub> = 1.8 V                                | 4.0 | 2.0                | -   | ns   |
|                  |                               | V <sub>CC</sub> = 2.3 V to 2.7 V                       | 3.0 | 1.6                | -   | ns   |
|                  |                               | V <sub>CC</sub> = 2.7 V                                | 3.0 | 1.6                | -   | ns   |
| t <sub>su</sub>  | set-up time                   | V <sub>CC</sub> = 3.0 V to 3.6 V                       | 2.5 | 1.4                | -   | ns   |
|                  |                               | Dn to nCP; see <a href="#">Figure 8</a>                |     |                    |     |      |
|                  |                               | V <sub>CC</sub> = 1.8 V                                | 1.5 | 0.2                | -   | ns   |
|                  |                               | V <sub>CC</sub> = 2.3 V to 2.7 V                       | 1.2 | 0.2                | -   | ns   |
|                  |                               | V <sub>CC</sub> = 2.7 V                                | 1.5 | 0.4                | -   | ns   |
| t <sub>h</sub>   | hold time                     | V <sub>CC</sub> = 3.0 V to 3.6 V                       | 1.2 | 0.2                | -   | ns   |
|                  |                               | Dn to nCP; see <a href="#">Figure 8</a>                |     |                    |     |      |
|                  |                               | V <sub>CC</sub> = 1.8 V                                | 0.6 | -0.2               | -   | ns   |
|                  |                               | V <sub>CC</sub> = 2.3 V to 2.7 V                       | 0.8 | -0.1               | -   | ns   |
|                  |                               | V <sub>CC</sub> = 2.7 V                                | 0.6 | -0.2               | -   | ns   |
| C <sub>PD</sub>  | power dissipation capacitance | V <sub>CC</sub> = 3.0 V to 3.6 V                       | 0.8 | 0.0                | -   | ns   |
|                  |                               | per flip-flop; V <sub>I</sub> = GND to V <sub>CC</sub> |     |                    |     |      |
|                  |                               | outputs enabled                                        | -   | 16                 | -   | pF   |
|                  |                               | outputs disabled                                       | -   | 10                 | -   | pF   |

[1] All typical values are measured at T<sub>amb</sub> = 25 °C.[2] Typical values are measured at V<sub>CC</sub> = 2.5 V.[3] Typical values are measured at V<sub>CC</sub> = 3.3 V.[4] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.t<sub>en</sub> is the same as t<sub>PZL</sub> and t<sub>PZH</sub>.t<sub>dis</sub> is the same as t<sub>PLZ</sub> and t<sub>PHZ</sub>.[5] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).P<sub>D</sub> = C<sub>PD</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>i</sub> × N + Σ(C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) where:f<sub>i</sub> = input frequency in MHz; f<sub>o</sub> = output frequency in MHz;C<sub>L</sub> = output load capacitance in pF;V<sub>CC</sub> = supply voltage in Volts;

N = number of inputs switching;

Σ(C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) = sum of the outputs.

11. Waveforms

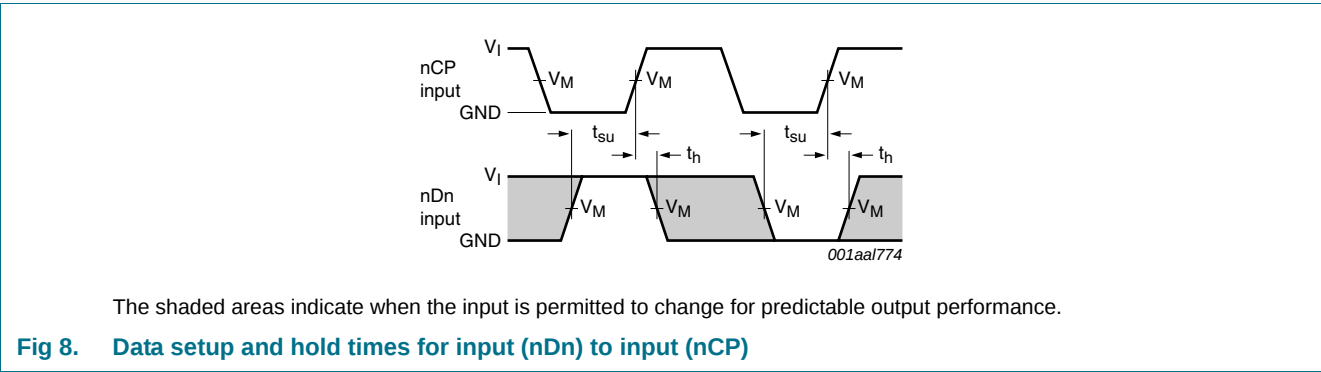
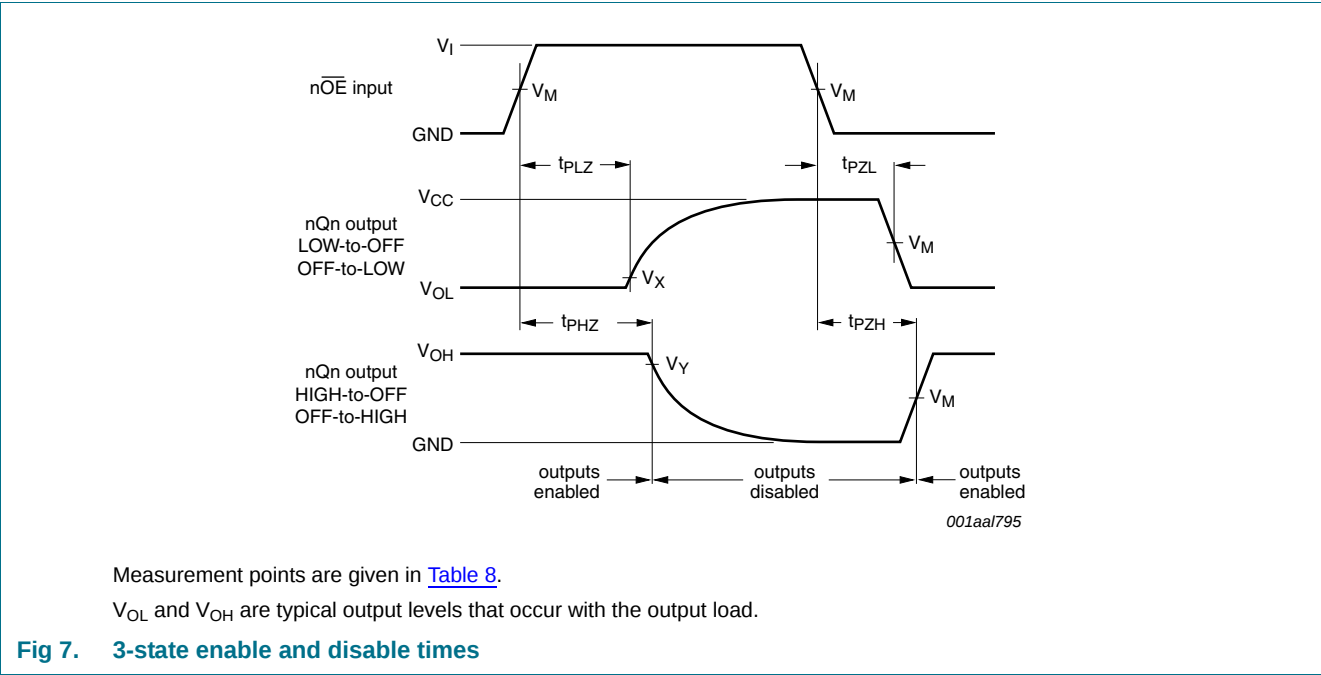
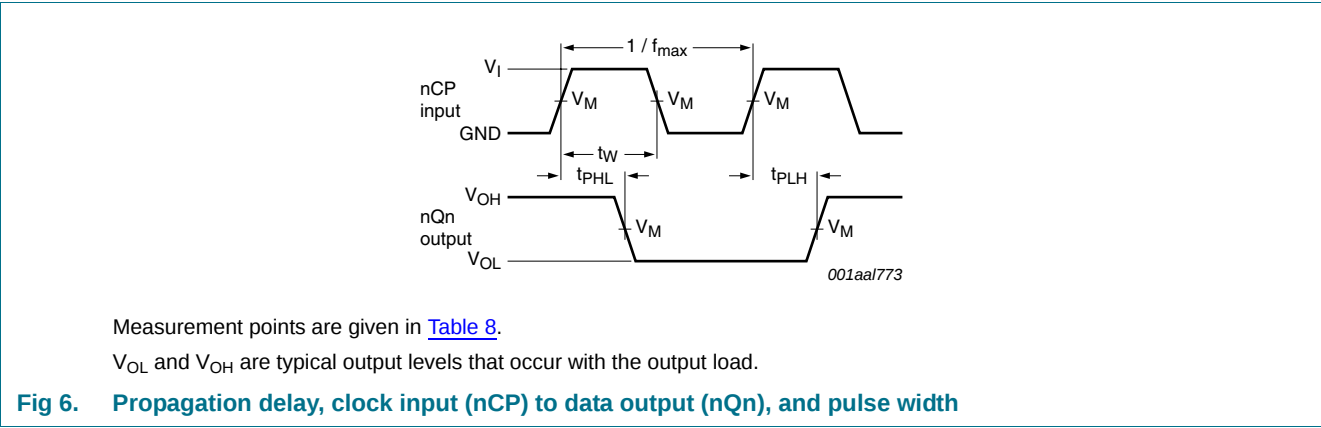
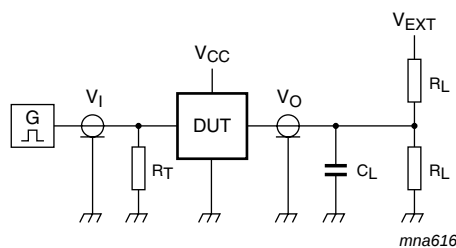


Table 8. Measurement points

| Supply voltage             | Input    |       | Output |                          |                          |
|----------------------------|----------|-------|--------|--------------------------|--------------------------|
| $V_{CC}$                   | $V_I$    | $V_M$ | $V_M$  | $V_X$                    | $V_Y$                    |
| 2.3 V to 2.7 V and < 2.3 V | $V_{CC}$ | 0.5   | 0.5    | $V_{OL} + 0.15\text{ V}$ | $V_{OH} - 0.15\text{ V}$ |
| 2.7 V                      | 2.7 V    | 2.7 V | 1.5 V  | $V_{OL} + 0.3\text{ V}$  | $V_{OH} - 0.3\text{ V}$  |
| 3.0 V to 3.6 V             | 2.7 V    | 2.7 V | 1.5 V  | $V_{OL} + 0.3\text{ V}$  | $V_{OH} - 0.3\text{ V}$  |

## 12. Test information



Test data is given in [Table 9](#).

Definitions for test circuit:

$R_L$  = Load resistance.

$C_L$  = Load capacitance including jig and probe capacitance.

$R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

$V_{EXT}$  = External voltage for measuring switching times.

Fig 9. Load circuit for measuring switching times

Table 9. Test data

| Supply voltage             | Input    |                      | Load  |              | $V_{EXT}$          |                    |                    |
|----------------------------|----------|----------------------|-------|--------------|--------------------|--------------------|--------------------|
| $V_{CC}$                   | $V_I$    | $t_r, t_f$           | $C_L$ | $R_L$        | $t_{PLH}, t_{PHL}$ | $t_{PLZ}, t_{PZL}$ | $t_{PHZ}, t_{PZH}$ |
| 2.3 V to 2.7 V and < 2.3 V | $V_{CC}$ | $\leq 2.0\text{ ns}$ | 30 pF | 500 $\Omega$ | open               | $2 \times V_{CC}$  | GND                |
| 2.7 V                      | 2.7 V    | 2.5 ns               | 50 pF | 500 $\Omega$ | open               | $2 \times V_{CC}$  | GND                |
| 3.0 V to 3.6 V             | 2.7 V    | 2.5 ns               | 50 pF | 500 $\Omega$ | open               | $2 \times V_{CC}$  | GND                |

13. Package outline

SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1

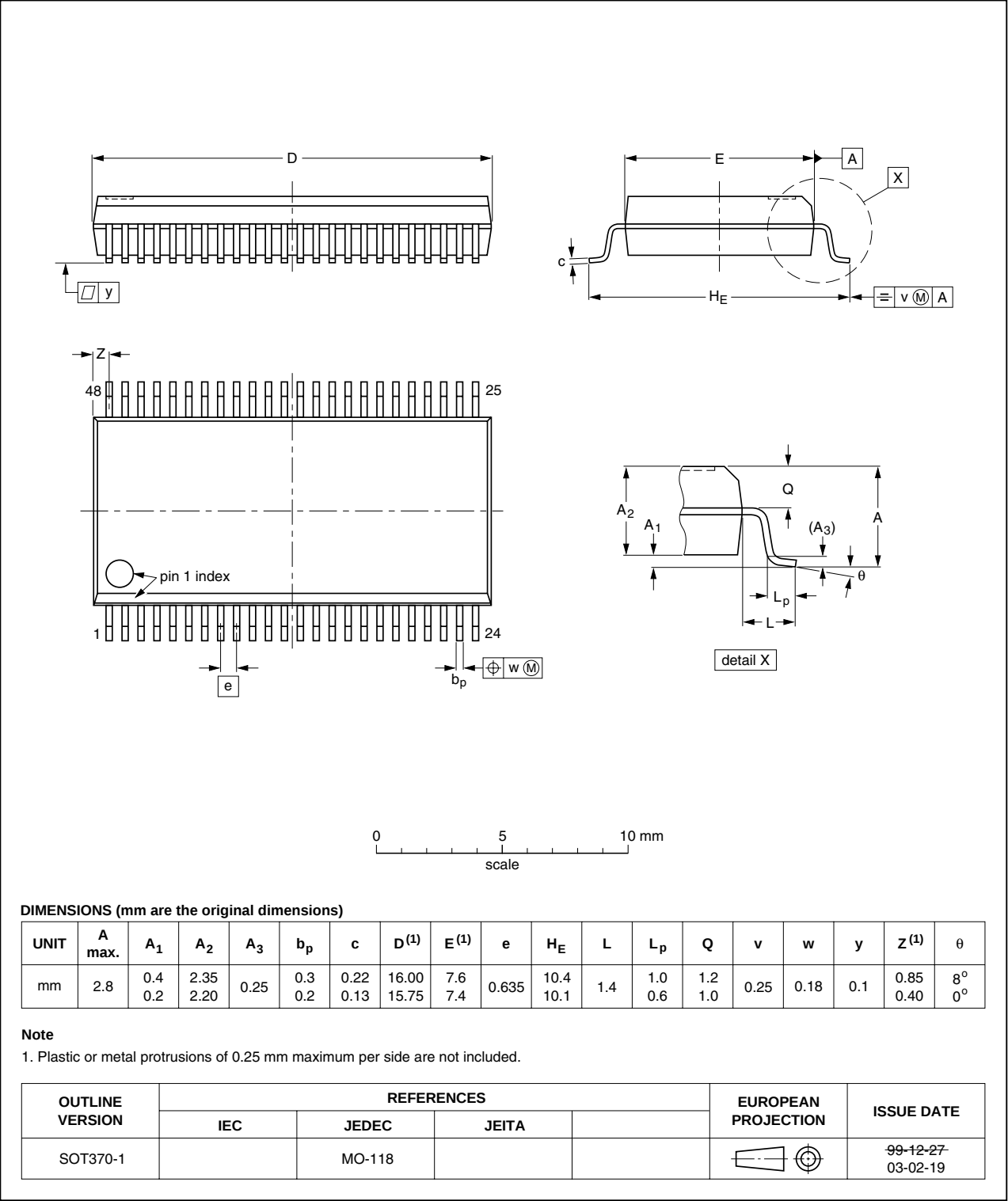


Fig 10. Package outline SOT370-1 (SSOP48)

TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1 mm

SOT362-1

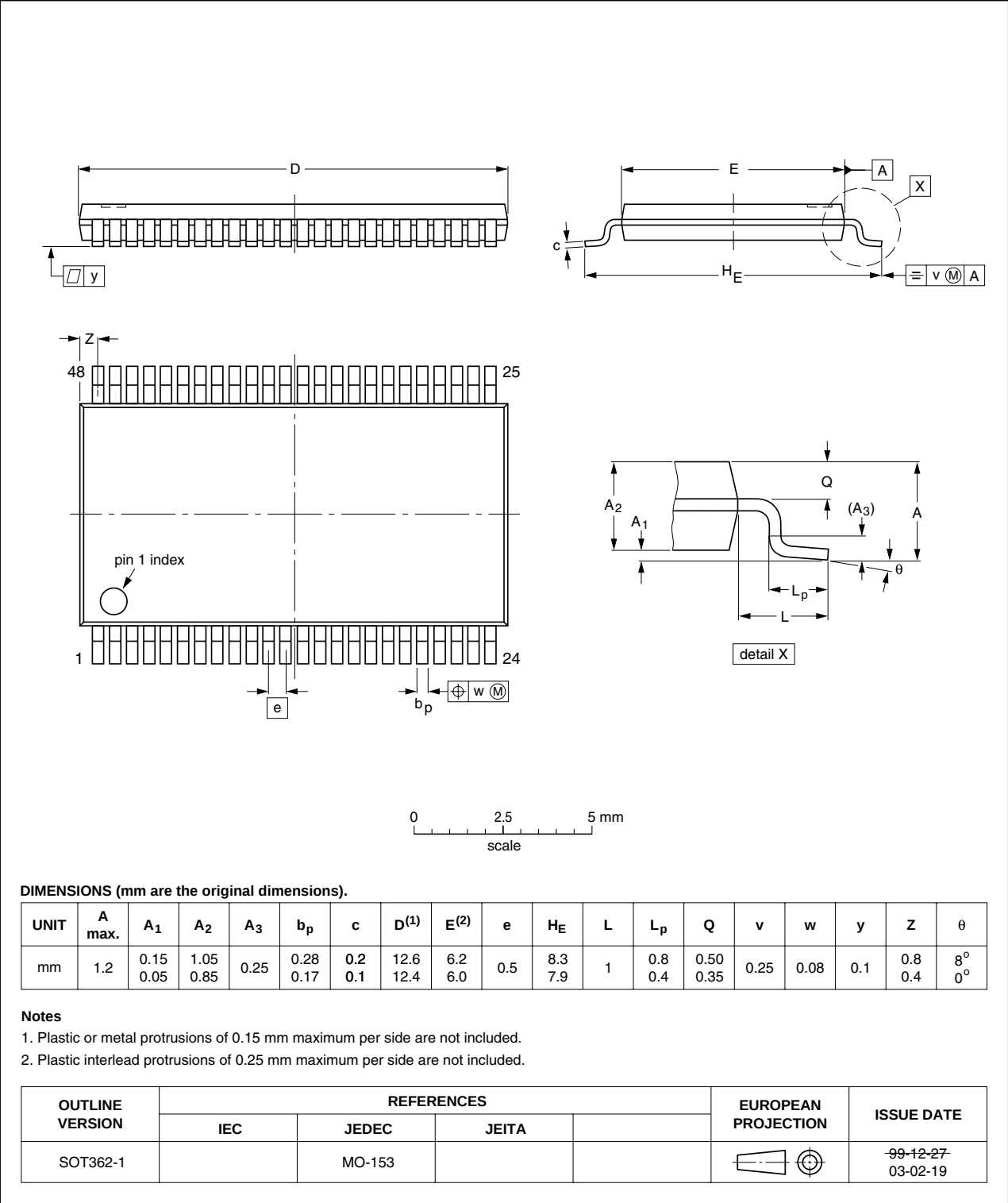


Fig 11. Package outline SOT362-1 (TSSOP48)

## 14. Abbreviations

Table 10. Abbreviations

| Acronym | Description                             |
|---------|-----------------------------------------|
| CMOS    | Complementary Metal-Oxide Semiconductor |
| DUT     | Device Under Test                       |
| ESD     | ElectroStatic Discharge                 |
| HBM     | Human Body Model                        |
| MM      | Machine Model                           |
| TTL     | Transistor-Transistor Logic             |

## 15. Revision history

Table 11. Revision history

| Document ID                                                                                                           | Release date | Data sheet status     | Change notice | Supersedes     |
|-----------------------------------------------------------------------------------------------------------------------|--------------|-----------------------|---------------|----------------|
| 74ALVCH16374_3                                                                                                        | 20100427     | Product data sheet    | -             | 74ALVCH16374_2 |
| Modifications:                                                                                                        |              |                       |               |                |
| - The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. |              |                       |               |                |
| - Legal texts have been adapted to the new company name where appropriate.                                            |              |                       |               |                |
| - <a href="#">Table 7 "Dynamic characteristics"</a> : voltage ranges corrected.                                       |              |                       |               |                |
| 74ALVCH16374_2                                                                                                        | 19980618     | Product specification | -             | 74ALVCH16374_1 |

## 16. Legal information

### 16.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition                                                                            |
|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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